Imagine the invisible



Xeva-2.5-320 TE4

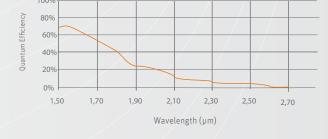
Versatile SWIR T2SL camera with response up to 2.5 µm

Superior performance for reliable research

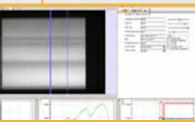
The Xeva-2.5-320 is a compact digital camera operating a T2SL detector array for imaging in the 1.0 to 2.5 μm wavelength range. The camera features a resolution of 320 x 256 pixels with a 30 μm pixel pitch. It outputs 14-bit data and comes in a 100 Hz or 350 Hz version.

The camera interfaces to a PC via standard USB 2.0 and CameraLink. Each camera is delivered with a Graphical User Interface (GUI) Xeneth, which offers direct access to various camera settings such as exposure time and operating temperature.

Through its advanced thermomechanical design, the Xeva-2.5-320 achieves excellent performance levels using a TE4-cooled device operating down to 203K.



Designed for use in







Applications

- R&D (SWIR range)
- · Semiconductor inspection
- · Hyperspectral SWIR imaging
- Art inspection (seeing through paint)
- Laser beam profiling (1.0 2.5 μm)

Benefits & Features

- Spectrometer compatible
- CameraLink for high speed imaging
- Scientific image recording and analysis
- High speed SWIR imaging up to 2.5 μm
- Windowing mode for even higher frame rates
- Flexible programming in an open architecture
- Smallest TE4-cooled camera for low dark current
- Two gain modes for High Sensitivity (HS) or High Dynamic Range (HDR)

Complete camera and software package to simplify your research Lens & filter options





- · ·
 - Xeneth SDK (optional)
- Outputs Xeneth LabVIEW SDK (optional)

▶ Specifications

Visible lens, 16 mm f/1.4 C-Mount 100 Hz No Snapshot High gain: 150 electrons; HDR": 1000 electrons	344 Hz full frame; > 10 kHz at 128x8 window Minimum 128 x 8 pixels			
C-Mount 100 Hz No Snapshot High gain: 150 electrons;	> 10 kHz at 128x8 window			
100 Hz No Snapshot High gain: 150 electrons;	> 10 kHz at 128x8 window			
No Snapshot High gain: 150 electrons;	> 10 kHz at 128x8 window			
No Snapshot High gain: 150 electrons;	> 10 kHz at 128x8 window			
Snapshot High gain: 150 electrons;	Minimum 128 x 8 pixels			
High gain: 150 electrons;				
High gain: 10 electrons/ADU; HDR**: 210 electrons/ADU 14 bit per pixel				
USB 2.0				
CameraLink or USB 2.0	CameraLink			
TTL Levels				
Xeneth Advanced				
7W without cooling; 84 W @ maximum cooling				
Forced convection cooling Approximately 2 minutes O to 40 °C				
		87 W x 115 H x 109 L mm ³		
		App. 1.8 kg (without lens)		
	High gain: 10 electrons/ADU HDR*: 210 electrons/ADU 14 bit per pixel USB 2.0 CameraLink or USB 2.0 TTL Levels Xeneth Advanced 7W without cooling; 84 W @ 24 V Forced convection cooling Approximately 2 minutes 0 to 40 °C 87 W x 115 H x 109 L mm³			

^{*} Typical value

Array specifications	Xeva-2.5-320
Array type	T2SL
Spectral band	1.0 μm to 2.5 μm
Resolution	320 x 256
Pixel pitch	30 μm
Array dimensions	W: 9.6 mm H: 7.68 mm D: 12.29 mm or 0.48 in
ROIC noise	High gain: 70 electrons; Low gain: 700 electrons
Integration capacitor	High gain: 10 fF; Low gain: 210 fF
Full well	High gain: 0.17 x 10 ⁶ electrons Low gain: 3.5 x 10 ⁶ electrons
Array cooling	TEC 4 stages (typical sensor temperature 203 K or -70 °C)
Pixel operability	> 99 %
Dark current*	150 x 10 ⁶ e-/s/pixel

▶ Product selector guide

Part number	Date interface	Cooling	Frame rate	ADC
XEN-000617	CL/USB	TE4	100 Hz	47 1:4
XEN-000618	CL		344 Hz	14 bit

▶ Lenses (optional)

Part number	Focal length	F#	Wavelength range
OPT-000236	25 mm	f/2.5	0.9 μm - 2.5 μm
OPT-000237	35 mm	f/2.0	0.9 μm - 2.5 μm
OPT-000238	50 mm	f/2.0	0.9 μm - 2.5 μm



[&]quot; High Dynamic Range mode